

2RB-8 Series

Description

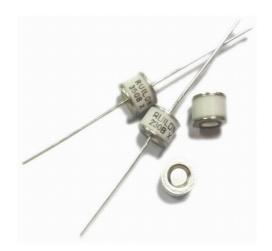
GDT is placed in front of, and in parallel with, sensitive telecom equipment such as power lines, communication lines, signal lines and data transmission lines to help protect them from damage caused by transient surge voltages that may result from lightning strikes and equipment switching operations. These devices do not influence the signal in normal operation. However, in the event of an overvoltage surge, such as a lightning strike, the GDT switches to a low impedance state and diverts the energy away from the sensitive equipment.

Our GDT offer a high level of surge protection, a broad voltage range, low capacitance, and many form factors including new surface mount devices, which makes them suitable for applications such as Main Distribution Frame (MDF) modules, high data-rate telecom applications (e.g. ADSL, VDSL), and surge protection on power lines. Their low capacitance also results in less signal distortion. When used in a coordinated circuit protection solution with PolySwitch devices, they can help equipment manufacturers meet stringent safety regulatory standards.

Features

- I Excellent response to fast rising transients
- I Stable breakdown voltage
- I GHz working frequency
- I 8/20µs Impulse current capability: 10KA
- I Non-Radioactive
- I Ultra Low capacitance (<1.5pF)
- I Lead-free and RoHS compliant
- I UL 497B Recognized: E465335
- I Size: 8.3mm*6mm
- I Storage and operational temperature: -40~+90°C

Part Number Code

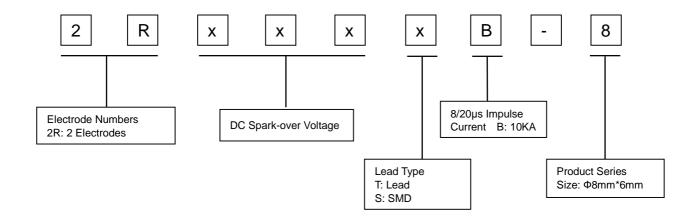


Electrical symbol



Applications

- I MDF modules
- I xDSL equipment
- I RF systems
- I Antenna
- Base stations
- I Repeaters, Modems
- I Telephone Interface, Line cards
- I Data communication equipment
- I Line test equipment
- I Power supplies
 - Surge protectors, Alarm systems



361°Circuit Protection System



2RB-8 Series

Electrical Characteristics

Impulse Spark-over Ins			Insulation	nsulation	Life Ratings					
Deci N		DC Spark-over	Spark-over Voltage		Resistance	Capacitance @1MHz	Impulse Discharge Current @8/20µS		AC Discharge Current @50Hz 1S	Impulse Life @10/1000µS 100A
Part N	umber	er Voltage ^{1) 2)} @100V/S		3 1KV/μS						
		@100V/S	Max	Мах	Min	Max	Nominal ±5 times	Max 1 time	Nominal 5 times	Min
DIP	SMD	v	v	v	GΩ	pF	KA	KA	А	Times
2R075TB-8	2R075SB-8	75±20%	500	600	1	1	10	12	10	300
2R090TB-8	2R090SB-8	90±20%	500	600	1	1	10	12	10	300
2R150TB-8	2R150SB-8	150±20%	500	600	1	1	10	12	10	300
2R230TB-8	2R230SB-8	230±20%	600	700	1	1	10	12	10	300
2R250TB-8	2R250SB-8	250±20%	600	700	1	1	10	12	10	300
2R300TB-8	2R300SB-8	300±20%	750	850	1	1	10	12	10	300
2R350TB-8	2R350SB-8	350±20%	800	900	1	1	10	12	10	300
2R420TB-8	2R420SB-8	420±20%	850	950	1	1	10	12	10	300
2R470TB-8	2R470SB-8	470±20%	900	1000	1	1	10	12	10	300
2R600TB-8	2R600SB-8	600±20%	1000	1200	1	1	10	12	10	300
2R800TB-8	2R800SB-8	800±20%	1300	1400	1	1	10	12	10	300
Glow Voltage at	10mA				~60V					
Arc Voltage at 1	A				~10V					
Glow to Arc transition Current				~0.5A	~0.5A					
Weight				~1.45g	~1.45g					
Operation and storage temperature				40~90°	-40~90°C					
Climatic category (IEC 60068-1)				40/090/2	40/090/21					
Marking, black			xxx B xxx -1 B -	B -Nominal Impulse Discharge Current						
Surface treatme	ent					Nickel Plated Matte-tin plated	ł			

¹⁾ At delivery AQL 0.65 level II, DIN ISO 2859

²⁾ In ionized mode

³⁾ Insulation Resistance Measuring Voltage:

75V at DC 25V

90V~150V at DC 50V

Other at DC 100V

Terms in accordance with ITU-T Rec. K.12, IEC 61643-311, GB/T 9043.

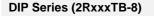
361°Circuit Protection System

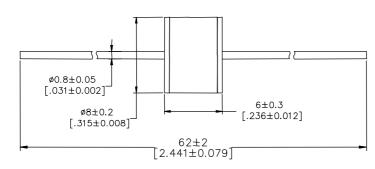


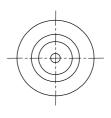
Inner box

150±2 [5.906±0.079] 2RB-8 Series

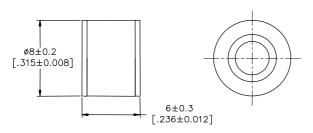
Dimensions (Unit: mm/inch)

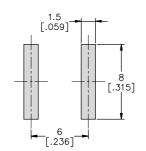






SMD Series (2RxxxSB-8)





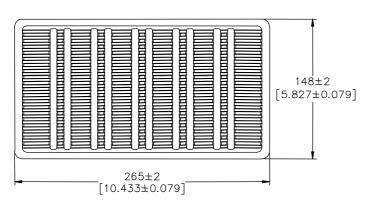
Recommended Soldering Pad Layout

275±2 [10.827±0.079]

Packaging Information (Unit: mm/inch)

Axial Packaging (Bulk)

Plastic Tray



Packaging Quantity:

100 PCS per Plastic Tray

5 Plastic Trays per inner box

500 PCS per inner box

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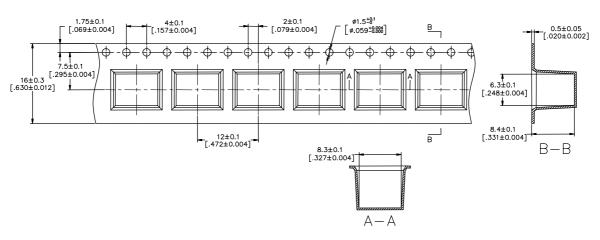
50±1 [1.969±0.039]



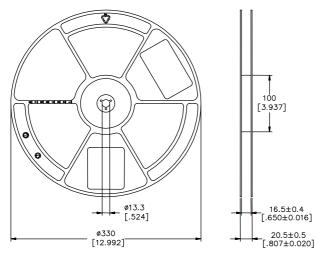
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SMD Packaging (Tape & Reel)

Таре



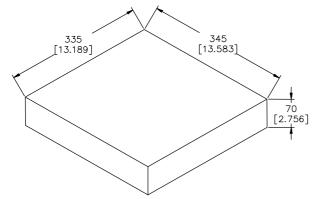
Reel



RUILON RUILON RUILON RUILON RUILON XXX B X XXX B X			• • •	•••
	RUILO	O RUILO	RUILO	RUILO
	XXX B X	xxx B x	XXX B I	XXX B X

Direction of Unreeling

Inner box



Packaging Quantity:

500 PCS per reel (13")

3 reels per inner box

1,500 PCS per inner box

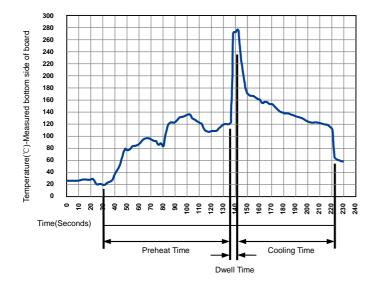
361° Circuit Protection System

Specifications are subject to change without notice. Please refer to http://**www.ruilon.com.cn** for current information.



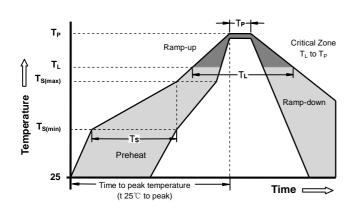
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Soldering Parameters - Wave soldering (Thru-Hole Devices)



Wave Soldering Condition		Pb-Free assembly	
	Temperature Min	100°C	
Preheat	Temperature Max	150°C	
	Time (Min to Max)	60-180 Seconds	
Solder Pot Temperature		280°C Max	
Solder Dwell Time		2-5 Seconds	

Soldering Parameters - Reflow Soldering (Surface Mount Devices)



Reflow Condition		Pb - Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Preheat	-Temperature Max (T _{s(max)})	200°C	
	- Time (min to max) (t _s)	60 -180 Seconds	
Average ramp up rate (Liquids Temp T _L) to peak		3°C/second max	
T _{S(max)} to TL - Ramp-up Rate		5°C/second max	
Reflow	- Temperature (T _L) (Liquids)	217°C	
	- Time (min to max) (t_s)	60 -150 Seconds	
Peak Temperature (T _P)		260 +0/-5°C	
Time within 5°C of actual peak Temperature (t _p)		10 - 30 Seconds	
Ramp-dow	vn Rate	6°C/second max	
Time 25°C	to peak Temperature (T _P)	8 minutes Max	
Do not exc	ceed	260°C	

